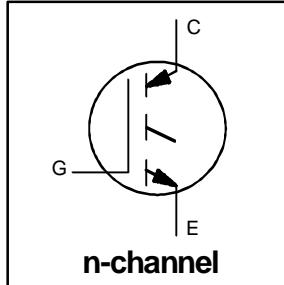


Features

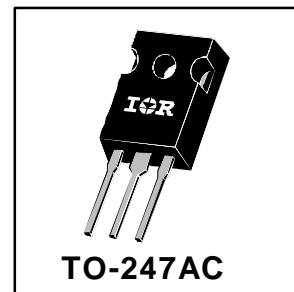
- Switching-loss rating includes all "tail" losses
- Optimized for line frequency operation (to 400Hz)



$V_{CES} = 1200V$
 $V_{CE(sat)} \leq 3.0V$
 @ $V_{GE} = 15V$, $I_C = 13A$

Description

Insulated Gate Bipolar Transistors (IGBTs) from International Rectifier have higher usable current densities than comparable bipolar transistors, while at the same time having simpler gate-drive requirements of the familiar power MOSFET. They provide substantial benefits to a host of high-voltage, high-current applications.



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Voltage	1200	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	22	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	13	
I_{CM}	Pulsed Collector Current ①	44	
I_{LM}	Clamped Inductive Load Current ②	44	
V_{GE}	Gate-to-Emitter Voltage	± 20	V
E_{ARV}	Reverse Voltage Avalanche Energy ③	10	mJ
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	100	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	13	
T_J	Operating Junction and	-55 to $+150$	$^\circ C$
T_{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf·in (1.1N·m)	

Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	—	—	1.2	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	—	0.24	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	—	40	
Wt	Weight	—	6 (0.21)	—	g (oz)

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage	1200	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 250\mu\text{A}$
$V_{(\text{BR})\text{ECS}}$	Emitter-to-Collector Breakdown Voltage ④	20	—	—	V	$V_{\text{GE}} = 0\text{V}, I_C = 1.0\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	1.5	—	$\text{V}/^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}, I_C = 1.0\text{mA}$
$V_{\text{CE}(\text{on})}$	Collector-to-Emitter Saturation Voltage	—	2.0	3.0	V	$I_C = 13\text{A}$
		—	2.8	—		$I_C = 22\text{A}$
		—	2.6	—		$I_C = 13\text{A}, T_J = 150^\circ\text{C}$
		3.0	—	5.5		$V_{\text{CE}} = V_{\text{GE}}, I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-12	—	$\text{mV}/^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}, I_C = 250\mu\text{A}$
g_{fe}	Forward Transconductance ⑤	3.1	6.3	—	S	$V_{\text{CE}} = 100\text{V}, I_C = 13\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	250	μA	$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 1200\text{V}$
		—	—	1000	$V_{\text{GE}} = 0\text{V}, V_{\text{CE}} = 1200\text{V}, T_J = 150^\circ\text{C}$	
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{\text{GE}} = \pm 20\text{V}$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	28	42	nC	$I_C = 13\text{A}$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	8.2	12		$V_{\text{CC}} = 400\text{V}$
Q_{gc}	Gate - Collector Charge (turn-on)	—	6.8	10		$V_{\text{GE}} = 15\text{V}$
$t_{d(\text{on})}$	Turn-On Delay Time	—	28	—	ns	$T_J = 25^\circ\text{C}$
t_r	Rise Time	—	22	—		$I_C = 13\text{A}, V_{\text{CC}} = 960\text{V}$
$t_{d(\text{off})}$	Turn-Off Delay Time	—	1200	1800		$V_{\text{GE}} = 15\text{V}, R_G = 23\Omega$
t_f	Fall Time	—	680	1140		Energy losses include "tail"
E_{on}	Turn-On Switching Loss	—	0.90	—	mJ	
E_{off}	Turn-Off Switching Loss	—	12	—		
E_{ts}	Total Switching Loss	—	13	19		
$t_{d(\text{on})}$	Turn-On Delay Time	—	26	—	ns	$T_J = 150^\circ\text{C}, I_C = 13\text{A}, V_{\text{CC}} = 960\text{V}$
t_r	Rise Time	—	27	—		$V_{\text{GE}} = 15\text{V}, R_G = 23\Omega$
$t_{d(\text{off})}$	Turn-Off Delay Time	—	1280	—		Energy losses include "tail"
t_f	Fall Time	—	2000	—		
E_{ts}	Total Switching Loss	—	23	—	mJ	
L_E	Internal Emitter Inductance	—	13	—	nH	Measured 5mm from package
C_{ies}	Input Capacitance	—	685	—	pF	$V_{\text{GE}} = 0\text{V}$
C_{oes}	Output Capacitance	—	43	—		$V_{\text{CC}} = 30\text{V}$
C_{res}	Reverse Transfer Capacitance	—	8.3	—		$f = 1.0\text{MHz}$

Notes:

- ① Repetitive rating; $V_{\text{GE}}=20\text{V}$, pulse width limited by max. junction temperature.
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ⑤ Pulse width $5.0\mu\text{s}$, single shot.
- ② $V_{\text{CC}}=80\%(V_{\text{CES}})$, $V_{\text{GE}}=20\text{V}$, $L=10\mu\text{H}$, $R_G=23\Omega$
- ④ Pulse width $\leq 80\mu\text{s}$; duty factor $\leq 0.1\%$.

Refer to Section D - page D-13**Package Outline 3 - JEDEC Outline TO-247AC (TO-3P)**